128Mb (2M-4Bank-16) Synchronous DRAM

Features

- Fully Synchronous to Positive Clock Edge
- Single 3.3V \pm 0.3V Power Supply
- LVTTL Compatible with Multiplexed Address
- Programmable Burst Length (B/L) 1, 2, 4, 8 or Full Page
- Programmable CAS Latency (C/L) 2 or 3
- Data Mask (DQM) for Read / Write Masking
- Programmable Wrap Sequence
 - Sequential (B/L = 1/2/4/8/full Page)
 - Interleave (B/L = 1/2/4/8)
- Burst Read with Single-bit Write Operation
- All Inputs are sampled at the Rising Edge of the System Clock
- Auto Refresh and Self Refresh
- 4,096 Refresh Cycles / 64ms (15.6us)

Description

The EM488M1644VTG is Synchronous Dynamic Random Access Memory (SDRAM) organized as 2Meg words x 4 banks by 16 bits. All inputs and outputs are synchronized with the positive edge of the clock.

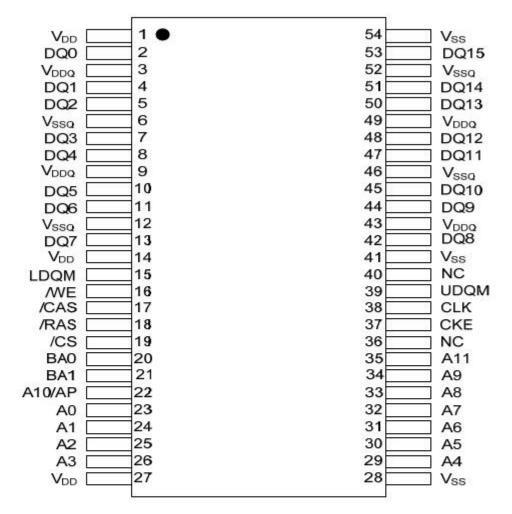
The 128Mb SDRAM uses synchronized pipelined architecture to achieve high speed data transfer rates and is designed to operate at 3.3V low power memory system. It also provides auto refresh with power saving / down mode. All inputs and outputs voltage levels are compatible with LVTTL.

EM488M1644VTG is available in TSOPII 54Pin package.

Ordering Information

Part No	Organization	Max. Freq	Package	Grade	Pb
EM488M1644VTG-7F	8M X 16	143MHz @CL3	54pin TSOPII	Commercial	Free
EM488M1644VTG-6F	8M X 16	166MHz @CL3	54pin TSOPII	Commercial	Free
EM488M1644VTG-7FE	8M X 16	143MHz @CL3	54pin TSOPII	Extended	Free
EM488M1644VTG-6FE	8M X 16	166MHz @CL3	54pin TSOPII	Extended	Free

Pin Assignment



54pin TSOP-II

Pin Description (Simplified)

Pin	Name	Function
38	CLK	(System Clock)
	02.1	Master clock input (Active on the positive rising edge)
19	/CS	(Chip Select)
		Selects chip when active
		(Clock Enable)
37	CKE	Activates the CLK when "H" and deactivates when "L".
		CKE should be enabled at least one cycle prior to new
		command. Disable input buffers for power down in standby.
		(Address)
		Row address (A0 to A11) is determined by A0 to A11 level at
		the bank active command cycle CLK rising edge.
00 00 00 04		CA (CA0 to CA8) is determined by A0 to A8 level at the read or
23~26, 29~34,	A0~A11	write command cycle CLK rising edge.
22, 35		And this column address becomes burst access start address.
		A10 defines the pre-charge mode. When A10= High at the
		pre-charge command cycle, all banks are pre-charged.
		But when A10= Low at the pre-charge command cycle, only the
		bank that is selected by BA0/BA1 is pre-charged.
20, 21	BA0, BA1	(Bank Address) Selects which bank is to be active.
		(Row Address Strobe)
18	/RAS	Latches Row Addresses on the positive rising edge of the CLK
10	/10/10	with /RAS "L". Enables row access & pre-charge.
		(Column Address Strobe)
17	/CAS	Latches Column Addresses on the positive rising edge of the
	70710	CLK with /CAS low. Enables column access.
		(Write Enable)
16	/WE	Latches Column Addresses on the positive rising edge of the
		CLK with /CAS low. Enables column access.
20. 45	LIDOM L DOM	(Data Input/Output Mask)
39, 15	UDQM, LDQM	DQM controls I/O buffers.
2, 4, 5, 7, 8, 10,		(Data Input/Output)
11, 13, 42, 44, 45,	DQ0~DQ15	DQ pins have the same function as I/O pins on a conventional
47, 48, 50, 51, 53		DRAM.
1,14,27/	V _{DD} /Vss	(Power Supply/Ground)
28,41,54	V 100 V 33	VDD and Vss are power supply pins for internal circuits.
3, 9, 43, 49/	Vddq/Vssq	(Power Supply/Ground)
6, 12, 46, 52	* 22 d/ * 00 d	VDDQ and VssQ are power supply pins for the output buffers.
		(No Connection)
36,40	NC	This pin is recommended to be left No Connection on the
		device.

Absolute Maximum Rating

Symbol	Item	Rat	ting	Units
VIN, VOUT	Input, Output Voltage	-0.3 ~ \	V	
Vdd, Vddq	Power Supply Voltage -1 ~ +4.6			
Тор	Operating Temperature Range	Commercial	0 ~ +70	°C
IOF	Operating remperature rearige	Extended	-25 ~ +85	0
Тѕтс	Storage Temperature Range	-55 ~	+150	°C
PD	Power Dissipation		W	
los	Short Circuit Current	5	0	mA

Note: Caution Exposing the device to stress above those listed in Absolute Maximum Ratings could cause permanent damage. The device is not meant to be operated under conditions outside the limits described in the operational section of this specification. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

Capacitance (Vcc=3.3V, f=1MHz, TA=25°C)

Symbol	Parameter	Min.	Тур.	Max.	Units
Cclk	Clock Capacitance	-	-	3.5	pF
Сі	Input Capacitance for CLK, CKE, Address, /CS, /RAS, /CAS, /WE, DQML, DQMU	-	-	3.5	pF
Со	Input/Output Capacitance	-	-	5.5	рF

Recommended DC Operating Conditions (T_A=-0°C ~+70°C)

Symbol	Parameter	Min.	Тур.	Max.	Units
V _{DD}	Power Supply Voltage	3.0	3.3	3.6	V
V _{DDQ}	Power Supply Voltage (for I/O Buffer)	3.0	3.3	3.6	V
ViH	Input Logic High Voltage	2.0		VDD+0.3	V
VIL	Input Logic Low Voltage	-0.3		0.8	V

Note: * All voltages referred to Vss.

* V_{IH} (max.) = 4.6V for pulse width \leq 10ns acceptable

* V_{IL} (min.) = -1.5V for pulse width \leq 10ns acceptable

Recommended DC Operating Conditions

(VDD, VDDQ= $3.3V\pm0.3V$, Vss=0V)

Symbol	Parameter	Test Conditions	Ma	ax.	Units
Symbol	i alametei	rest conditions	-6	-7	Office
Icc ₁	Operating Current (Note 1)	Operating Current (Note 1) Burst length=1, tRc≥tRc(min.), loL=0mA, One bank active		75	mA
Ісс2Р	Precharge Standby Current in	CKE≤Vı∟(max.), tcк=min	10	10	mA
ICC2PS	Power Down Mode	CKE≤Vı∟(max.), tcк= ∞	5	5	mA
Icc2N	Precharge Standby Current in	CKE≥Vı∟(min.), tcк=min, /CS=Vıн	30	30	mA
Icc2NS	Non-power Down Mode	CKE≥Vı∟(min.), tcк= ∞ , Input signals are stable	25	25	mA
Іссзр	Active Standby Current in Power Down Mode	CKE≤Vı∟(max.), tcκ=min 4 banks active	30	30	mA
Іссзи	Active Standby Current in Non-power Down Mode	$\frac{1}{C} = \frac{1}{C} = \frac{1}$		45	mA
Icc4	Operating Current (Burst Mode) (Note 2)			90	mA
ICC5	Auto Refresh Current (Note 3)	tck=min	115	100	mA
Icc6	Self Refresh Current	CKE≤0.2V	5	5 ^(Note 4)	mA

^{*}All voltages referenced to Vss.

Note 1: lcc1 depends on output loading and cycle rates.

Specified values are obtained with the output open.

Input signals are changed only one time during tck (min.)

Note 2: lcc4 depends on output loading and cycle rates.

Specified values are obtained with the output open.

Input signals are changed only one time during tck (min.)

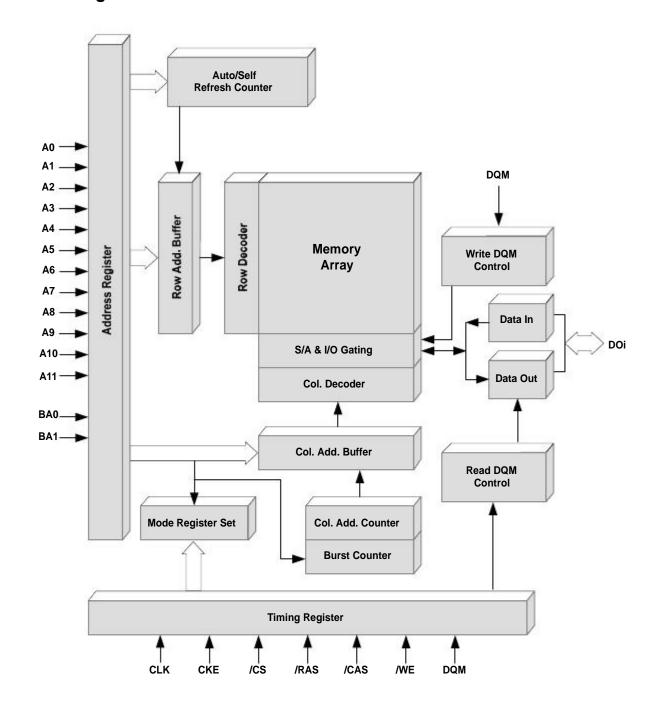
Note 3: Input signals are changed only one time during tck (min.)

Note 4: Standard power version.

Recommended DC Operating Conditions (Continued)

Symbol	Parameter	Test Conditions			Max.	Units
lı∟	Input Leakage Current	0≤Vı≤V _{DDQ} , V _{DDQ} =V _{DD} All other pins not under test=0V	-10		+10	uA
lol	Output Leakage Current	0≤Vо≤Vрра, Douт is disabled	-10		+10	uA
Vон	High Level Output Voltage	Io=-4mA	2.4			V
Vol	Low Level Output Voltage	lo=+4mA			0.4	V

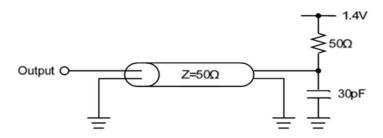
Block Diagram



AC Operating Test Conditions

 $(V_{DD}, V_{DDQ} = 3.3V \pm 0.3V, V_{SS} = 0V)$

Item	Conditions				
Output Reference Level	1.4V/1.4V				
Output Load	See diagram as below				
Input Signal Level	2.4V/0.4V				
Transition Time of Input Signals	1ns				
Input Reference Level	1.4V				



AC Operating Test Characteristics

 $(V_{DD}, V_{DDQ} = 3.3V \pm 0.3V, V_{SS} = 0V)$

Symbol	Symbol Parameter				-7		Units	
Cymbol	T drameter		Min.	Max.	Min.	Max.	Offico	
t cĸ	Clock Cycle Time	CL=3	6	-	7	-	ns	
tok	Slock Cycle Time	CL=2	7.5	-	10	-	110	
tac	Access Time form CLK	CL=3	-	5.4	-	5.4	ns	
L AC	Access Time form OLK	CL=2	-	5.4	-	6	113	
tсн	CLK High Level Width		2.5	-	2.5	-	ns	
tcl	CLK Low Level Width	2.5	-	2.5	-	ns		
t ckH	Clock Input Hold Time	1	-	1	-	ns		
tcks	Clock Input Setup Time	1.5	-	1.5	-	ns		
tон	Data-out Hold Time	2.5	-	2.5	-	ns		
tHZ	Data-out High Impedance Tir	3	6	3	7	ns		
tız	Data-out Low Impedance Tin	1	-	1	-	ns		
tıн	Input Hold Time	1	-	1	-	ns		
tıs	Input Setup Time	1.5	-	1.5	-	ns		
Tos	Data-in Setup Time	1.5	-	1.5	-	ns		
tон	Data-in Hold Time		1	-	1	-	ns	

^{*} All voltages referenced to Vss.

Note 5: the defines the time at which the output achieve the open circuit condition and is not referenced to output voltage levels.

AC Operating Test Characteristics (Continued)

 $(V_{DD}, V_{DDQ} = 3.3V \pm 0.3V, V_{SS} = 0V)$

Symbol	Parameter	-	6	-	Units	
Symbol	i alametei	Min.	Max.	Min.	Max.	Office
trc	ACTIVE to ACTIVE Command Period (Note 6)	60	-	63	-	ns
tras	ACTIVE to PRECHARGE Command Period (Note 6)	42	100k	45	100k	ns
t RP	PRECHARGE to ACTIVE Command Period ^(Note 6)	15	-	15	-	ns
trcd	ACTIVE to READ/WRITE Delay Time (Note 6)	15	-	15	-	ns
t rrd	ACTIVE(one) to ACTIVE(another) Command (Note 6)	12	-	14	-	ns
tccp	READ/WRITE Command to READ/WRITE Command	1	-	1	-	CLK
t DPL	Date-in to PRECHARGE Command	2	-	2	-	CLK
twr	Write Recovery Time for Auto Precharge	2	-	2	-	CLK
t DQW	DQM Write Mask Latency	0	-	0	-	CLK
tpqz	DQM Data out Disable Latency	-	2	-	2	CLK
tref	Refresh Time (4,096 cycles)	-	64	-	64	ms
t srex	Self Refresh Exit Time	1	-	1	-	CLK

^{*} All voltages referenced to Vss.

Note 6: These parameters account for the number of clock cycles and depend on the operating frequency of the clock, as follows:

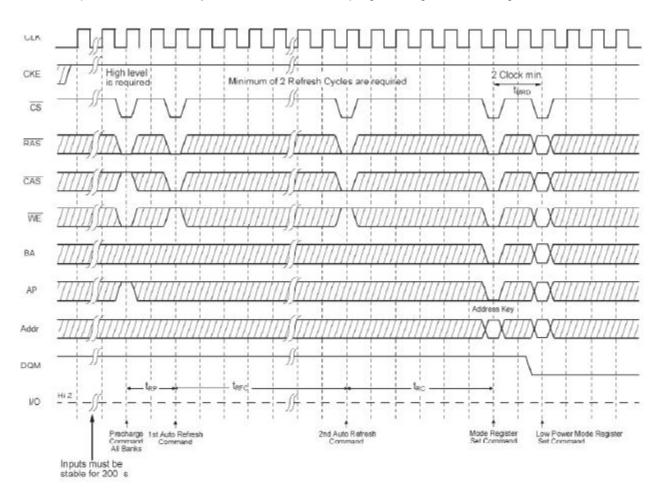
The number of clock cycles = Specified value of timing/clock period (Count Fractions as a whole number)

Recommended Power On and Initialization

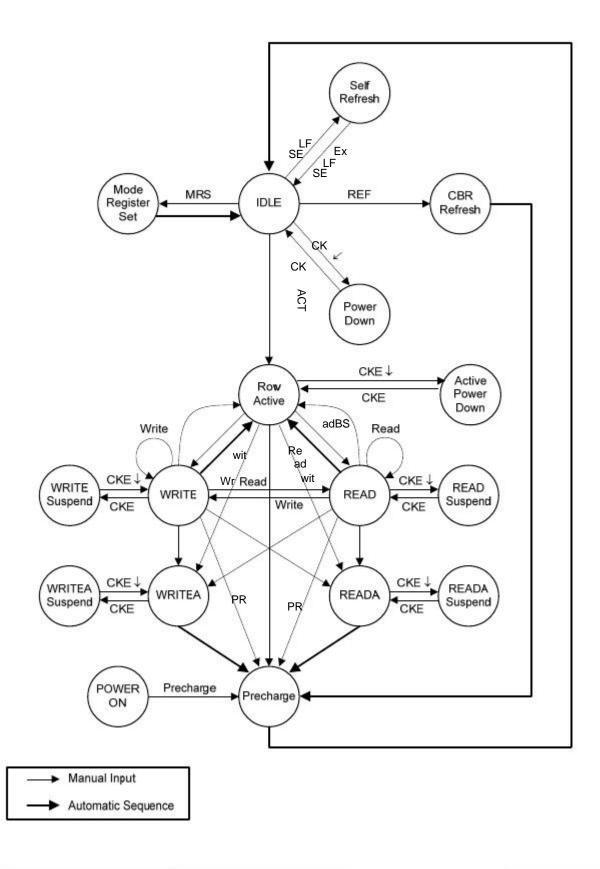
The following power on and initialization sequence guarantees the device is preconditioned to each user's specific needs. (Like a conventional DRAM) During power on, all V_{DD} and V_{DDQ} pins must be built up simultaneously to the specified voltage when the input signals are held in the "NOP" state. The power on voltage must not exceed V_{DD}+0.3V on any of the input pins or V_{DD} supplies. (CLK signal started at same time)

After power on, an initial pause of 200 µs is required followed by a precharge of all banks using the precharge command.

To prevent data contention on the DQ bus during power on, it is required that the DQM and CKE pins be held high during the initial pause period. Once all banks have been precharged, the Mode Register Set Command must be issued to initialize the Mode Register. A minimum of eight Auto Refresh cycles (CBR) are also required, and these may be done before or after programming the Mode Register.



Simplified State Diagram



Address Input for Mode Register Set

	2, 10		ration M		, 10	7 (7		S Later		BT		rst Len	
BA1	BA0	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0

BA1	BA0	A11	A10	A9	A8	A7	Operation Mode
0	0	0	0	0	0	0	Burst Read with Burst Write
0	0	0	0	1	0	0	Burst Read with Single Write

Burst Type (A3)

Burst Length	A2	A1	Α0	Sequential Addressing	Interleave Addressing
2	Х	Х	0	01	01
	Х	Х	0	10	10
	Х	0	0	0123	0123
4	Χ	0	1	1230	1032
4	Χ	1	0	2301	2301
	Χ	1	1	3012	3210
	0	0	0	01234567	01234567
	0	0	1	12345670	10325476
	0	1	0	23456701	23016745
8	0	1	1	34567012	32107654
	1	0	0	45670123	45670123
	1	0	1	56701234	54761032
	1	1	0	67012345	67452301
	1	1	1	70123456	76543210
Full Page*	n	n	n	Cn Cn+1 Cn+2	-

^{*} Page length is a function of I/O organization and column addressing -16 (CA0 ~ CA8): Full page = 512bits

1. Command Truth Table

Command	Symbol	CK	Ε	/CS	/RAS	/CAS	/WΕ	BA0,	A10	A11,
Command	Cymbol	n-1	n	,00	710.0	70710	, 	BA1	7110	A9~A10
Ignore Command	DESL	Η	Χ	Н	Χ	Χ	Χ	Χ	Χ	Χ
No Operation	NOP	Н	Х	L	Н	Н	Н	Χ	Χ	Χ
Burst Stop	BSTH	Η	Χ	L	Η	Н	L	Χ	Х	Х
Read	READ	Η	Χ	L	Η	L	Η	V	L	V
Read with Auto Pre-charge	READA	Н	Х	L	Н	L	Н	V	Н	٧
Write	WRIT	Η	Χ	L	Η	L	L	V	L	V
Write with Auto Pre-charge	WRITA	Η	Χ	L	Η	L	L	V	Η	٧
Bank Activate	ACT	Η	Χ	L	L	Н	Η	V	V	V
Pre-charge Select Bank	PRE	Η	Χ	L	L	Н	L	V	L	Χ
Pre-charge All Banks	PALL	Н	Х	L	L	Н	L	Χ	Н	Х
Mode Register Set	MRS	Н	Х	L	Ĺ	Ĺ	Ĺ	Ĺ	L	V

H = High level, L = Low level, X = High or Low level (Don't care), V = Valid data input

2. DQM Truth Table

Command	Symbol	Cl	KE	/CS	
Communa	Cymbol	n-1	n	700	
Data Write/Output Enable	ENB	Н	Х	Н	
Data Mask/Output Disable	MASK	Н	Х	L	
Upper Byte Write Enable/Output Enable	BSTH	Н	Х	L	
Read	READ	Н	Х	L	
Read with Auto Pre-charge	READA	Н	Х	L	
Write	WRIT	Н	Х	L	
Write with Auto Pre-charge	WRITA	Н	Х	L	
Bank Activate	ACT	Н	Х	L	
Pre-charge Select Bank	PRE	Н	Х	L	
Pre-charge All Banks	PALL	Н	Х	L	
Mode Register Set	MRS	Н	Х	L	

H = High level, L = Low level, X = High or Low level (Don't care), V = Valid data input

3. CKE Truth Table

Item	Command	Symbol	CK	Ε	/CS	/RAS	/CAS	WE	Addr.
		-,	n-1	n	,	,	,		
Activating	Clock Suspend Mode Entry		Н	L	Χ	X	Х	Χ	Χ
Any	Clock Suspend Mode		L	L	Χ	Х	Х	Χ	Χ
Clock Suspend	Clock Suspend Mode Exit		L	Н	Х	Х	Х	Х	Х
Idle	CBR Refresh Command	REF	Ι	Н	L	L	L	I	Χ
Idle	Self Refresh Entry	SELF	Η	L	L	L	L	Н	Χ
	Call Defeath Frit		Ы	Н	Ι	Х	Х	X	Χ
Self Refresh	Self Refresh Exit	-	L	Н	L	Н	Н	Х	Χ
Idle	Power Down Entry	-	Н	L	Н	Х	Х	Х	Х
13.13				_	L	Н	Н	Х	
Power Down	Power Down Exit	_	L	Н	Н	Х	Х	Х	Х
. cwc. bown	Tomor Bonn Exit	_	L		L	Н	Н	L	,,

Remark H = High level, L = Low level, X = High or Low level (Don't care)

4. Operative Command Table (Note 7)

Current State	/CS	/R	/C	/W	Addr.	Command	Action
	Н	Х	Х	Х	Х	DESL	Nop or power down (Note 8)
	L	Н	Н	Н	Х	NOP or BST	Nop
	L	Н	Н	L	BA/CA/A10	READ/READA	ILLEGAL ^(Note 9)
	L	Н	L	Х	BA/CA/A10	WRIT/WRITA	ILLEGAL (Note 9)
Idle	L	L	Н	Н	BA/RA	ACT	Row activating
	L	L	Н	L	BA, A10	PRE/PALL	Nop
	L	L	L	Н	Х	REF/SELF	Auto refresh or self refresh (Note 10)
	L	L	L	L	Op-Code	MRS	Mode register accessing
	Н	Χ	Χ	Χ	X	DESL	Nop
	L	Н	Н	Χ	Х	NOP or BST	Nop
	L	Н	L	Н	BA/CA/A10	READ/READA	Begin read: Determine AP (Note 11)
Row	L	Н	L	L	BA/CA/A10	WRIT/WRITA	Begin write: Determine AP (Note 11)
Active	L	L	Н	Н	BA/RA	ACT	ILLEGAL (Note 9)
	L	L	Н	L	BA, A10	PRE/PALL	Pre-charge (Note 12)
	L	L	L	Н	Χ	REF/SELF	ILLEGAL (Note 10)
	L	L	L	L	Op-Code	MRS	ILLEGAL
	Η	Χ	Χ	Χ	X	DESL	Continue burst to end → Row active
	L	Н	Н	Н	X	NOP	Continue burst to end → Row active
	L	Н	Н	L	X	BST	Burst stop → Row active
	L	Н	L	Н	BA/CA/A10	READ/READA	Terminate burst, new read: Determine AP (Note 13)
Read	L	Н	L	L	BA/CA/A10	WRIT/WRITA	Terminate burst, start write: Determine AP (Note 13, 14)
	L	L	Н	Н	BA/RA	ACT	ILLEGAL ^(Note 9)
	L	L	Н	L	BA, A10	PRE/PALL	Terminate burst, pre-charging (Note 10)
	L	L	L	Н	Х	REF/SELF	ILLEGAL
	L	L	L	L	Op-Code	MRS	ILLEGAL
	Н	Х	Х	Χ	Х	DESL	Continue burst to end → Write recovering
	L	Н	Н	Н	X	NOP	Continue burst to end → Write recovering
	L	Н	Н	L	X	BST	Burst stop → Row active
	L	н	L	Н	BA/CA/A10	READ/READA	Terminate burst, start read: Determine AP 7, 8 (Note 13, 14)
Write	L	Н	L	L	BA/CA/A10	WRIT/WRITA	Terminate burst, new write: Determine AP 7 (Note 13)
	L	L	Н	Н	BA/RA	ACT	ILLEGAL (Note 9)
	L	L	Н	L	BA, A10	PRE/PALL	Terminate burst, pre-charging (Note 15)
	L	L	L	Н	X	REF/SELF	ILLEGAL
	L	L	L	L	Op-Code	MRS	ILLEGAL

Remark H = High level, L = Low level, X = High or Low level (Don't care)

4. Operative Command Table (Continued) (Note 7)

Current State	/CS	/R	/C	W	Addr.	Command	Action
	Η	Х	Х	Х	Х	DESL	Continue burst to end → Pre-charging
	L	Н	Н	Н	X	NOP	Continue burst to end → Pre-charging
	L	Н	Н	L	Х	BST	ILLEGAL
Read with	L	Н	L	Н	BA/CA/A10	READ/READA	ILLEGAL (Note 9)
AP	L	Н	L	L	BA/CA/A10	WRIT/WRITA	ILLEGAL (Note 9)
	L	L	Н	Н	BA/RA	ACT	ILLEGAL (Note 9)
	L	L	Н	L	BA, A10	PRE/PALL	ILLEGAL (Note 9)
	L	L	L	Н	X	REF/SELF	ILLEGAL
	L	L	L	L	Op-Code	MRS	ILLEGAL
	Н	Х	Х	Х	Х	DESL	Burst to end → Write recovering with auto pre-charge
	L	Н	Н	Н	Х	NOP	Continue burst to end ☐ Write
	L	Н	Н	L	Х	BST	recovering with auto pre-charge ILLEGAL
Write with	L	Н	L	Н	BA/CA/A10	READ/READA	ILLEGAL (Note 9)
AP	L	Н	L	L	BA/CA/A10	WRIT/WRITA	ILLEGAL (Note 9)
	L	L	Н	Н	BA/RA	ACT	ILLEGAL (Note 9)
	L	L	Н	L	BA, A10	PRE/PALL	ILLEGAL (Note 9)
	L	L	L	Н	Х	REF/SELF	ILLEGAL
	L	L	L	L	Op-Code	MRS	ILLEGAL
	Н	Х	Χ	Χ	X	DESL	Nop → Enter idle after t _{RP}
	L	Н	Н	Н	Х	NOP	Nop → Enter idle after t _{RP}
	L	Н	Н	L	Х	BST	ILLEGAL
	L	Н	L	Н	BA/CA/A10	READ/READA	ILLEGAL (Note 9)
Pre-charging	L	Н	L	L	BA/CA/A10	WRIT/WRITA	ILLEGAL (Note 9)
	L	L	Н	Ι	BA/RA	ACT	ILLEGAL (Note 9)
	Ш	L	Н	Ш	BA, A10	PRE/PALL	Nop → Enter idle after t _{RP}
	L	L	L	Н	X	REF/SELF	ILLEGAL
	L	L	L	L	Op-Code	MRS	ILLEGAL
	Н	Χ	Х	Χ	Χ	DESL	Nop → Enter idle after tRCD
	L	Н	Н	Н	X	NOP	Nop → Enter idle after tRCD
	L	Н	Н	L	X	BST	ILLEGAL
Row	L	Н	L	Н	BA/CA/A10	READ/READA	ILLEGAL (Note 9)
Activating	L	Н	L	L	BA/CA/A10	WRIT/WRITA	ILLEGAL (Note 9)
	L	L	Н	Н	BA/RA	ACT	ILLEGAL (Note 9, 16)
	L	L	Н	L	BA, A10	PRE/PALL	ILLEGAL (Note 9)
	L	L	L	Н	Х	REF/SELF	ILLEGAL
	L	L	L	L	Op-Code	MRS	ILLEGAL

Remark H = High level, L = Low level, X = High or Low level (Don't care), AP = Auto Pre-charge

4. Operative Command Table (Continued) (Note 7)

Current State	/CS	/R	/C	/W	Addr.	Command	Action
	Ι	Χ	Χ	Χ	X	DESL	Nop → Enter row active after tdpl
	L	Н	Н	Η	X	NOP	Nop → Enter row active after tdpl
	L	Н	Н	L	X	BST	Nop → Enter row active after tdpl
	L	Н	L	Н	BA/CA/A10	READ/READA	Start read, Determine AP
Write Recovering	L	Н	L	L	BA/CA/A10	WRIT/WRITA	New write, Determine AP (Note 14)
Recovering	L	L	Н	Н	BA/RA	ACT	ILLEGAL (Note 9)
	L	L	Н	L	BA, A10	PRE/PALL	ILLEGAL (Note 9)
	L	L	L	Н	Х	REF/SELF	ILLEGAL
	L	L	L	L	Op-Code	MRS	ILLEGAL
	Η	Χ	Χ	Χ	Χ	DESL	Nop → Enter pre-charge after topL
	L	Н	Н	Н	X	NOP	Nop → Enter pre-charge after topL
	L	Н	Н	L	X	BST	ILLEGAL
Write	L	Н	L	Η	BA/CA/A10	READ/READA	ILLEGAL (Note 9, 14)
Recovering	L	Н	L	L	BA/CA/A10	WRIT/WRITA	ILLEGAL (Note 9)
with AP	L	L	Н	Н	BA/RA	ACT	ILLEGAL (Note 9)
	L	L	Н	L	BA, A10	PRE/PALL	ILLEGAL
	L	L	L	Н	Х	REF/SELF	ILLEGAL
	L	L	L	L	Op-Code	MRS	ILLEGAL
	Ι	Χ	Χ	Χ	X	DESL	Nop → Enter idle after t _{RC}
	L	Н	Н	Η	X	NOP/BST	Nop → Enter idle after t _{RC}
Refreshing	_ا	Η	Η	L	X	BST	ILLEGAL
rtonooning	L	Η	L	Χ	X	READ/WRIT	ILLEGAL
	_ا	L	Η	Χ	X	ACT/PRE/PALL	ILLEGAL
	_ا	L	L	Χ	X	REF/SELF/MRS	ILLEGAL
	Ι	Χ	Χ	Χ	X	DESL	Nop
Mode	L	Н	Н	Н	X	NOP	Nop
Mode Register	L	Η	Н	L	Χ	BST	ILLEGAL
Accessing	L	Η	L	Χ	Χ	READ/WRIT	ILLEGAL
	L	L	Х	Χ	Х	ACT/PRE/PALL/ REF/SELF/MRS	ILLEGAL

Remark H = High level, L = Low level, X = High or Low level (Don't care), AP = Auto Pre-charge

- Note 7: All entries assume that CKE was active (High level) during the preceding clock cycle.
- **Note 8:** If all banks are idle, and CKE is inactive (Low level), SDRAM will enter Power down mode. All input buffers except CKE will be disabled.
- Note 9: Illegal to bank in specified states;

Function may be legal in the bank indicated by Bank Address (BA), depending on the state of that bank.

- **Note 10:** If all banks are idle, and CKE is inactive (Low level), SDRAM will enter Self refresh mode. All input buffers except CKE will be disabled.
- Note 11: Illegal if tRCD is not satisfied.
- Note 12: Illegal if tras is not satisfied.
- Note 13: Must satisfy burst interrupt condition.
- Note 14: Must satisfy bus contention, bus turn around, and/or write recovery requirements.
- Note 15: Must mask preceding data which don't satisfy topl.
- Note 16: Illegal if trrd is not satisfied.

5. Command Truth Table for CKE

Current State		ΚE	/CS	/R	/C	W	Addr.	Action
	n-1	n	,00	,,,	, ,	,,,,	710011	
	Н	Х	Χ	Χ	Χ	Х	X	INVALID, CLK(n-1) would exit self refresh
	L	Н	Н	Χ	Χ	Χ	Χ	Self refresh recovery
Self Refresh	L	Н	L	Н	Н	Χ	Х	Self refresh recovery
	L	Н	L	Н	L	Χ	X	ILLEGAL
	L	Н	L	L	Х	Χ	Χ	ILLEGAL
	L	L	Χ	Χ	Х	Χ	X	Maintain self refresh
	Н	Н	Н	Χ	Х	Χ	X	Idle after trc
	Н	Н	L	Н	Н	Χ	X	Idle after trc
	Н	Н	L	Н	L	Χ	Χ	ILLEGAL
Self Refresh	Н	Н	L	L	Χ	Χ	X	ILLEGAL
Recovery	Н	L	Η	Χ	Χ	Χ	Х	ILLEGAL
	Н	L	L	Н	Н	Χ	Χ	ILLEGAL
	Н	L	L	Н	L	Χ	Χ	ILLEGAL
	Н	L	L	L	Χ	Χ	Х	ILLEGAL
Power Down	Н	Х	Χ	Х	Х	Х	Х	INVALID, CLK(n-1) would exit power down
Fower Down	L	Н	Х	Х	Х	Χ	Х	Exit power down → Idle
	L	L	Х	Χ	Χ	Χ	Х	Maintain power down mode
	Н	Н	Н	Х	Х	Χ		Refer to operations in Operative
	Н	Н	L	Н	Χ	Χ		Command Table
	Н	Н	L	L	Н	Χ		
	Н	Н	L	L	L	Н	Χ	Refresh
	Н	Н	L	L	L	L	Op-Code	
Both Banks	Н	L	Н	Χ	Χ	Χ		Refer to operations in Operative
Idle	Н	L	L	Н	Х	X		Command Table
	Н	L	L	L	Н	Х		(Note 47)
	Н	L	L	L	L	Ι	X	Self refresh (Note 17)
	Н	L	L	L	L	L	Op-Code	Refer to operations in Operative Command Table
	L	Χ	Χ	Х	Х	Χ	Х	Power down (Note 17)
Row Active	Н	Х	Х	Х	Х	Х	Х	Refer to operations in Operative Command Table
1.0117101170	L	Х	Х	Χ	Χ	Х	Х	Power down (Note 17)
	Н	Н	Х	Х	Х	Х		Refer to operations in Operative Command Table
Any State Other than Listed above	Н	L	Х	Х	Х	Х	Х	Begin clock suspend next cycle (Note 18)
	L	Н	Х	Χ	Х	Х	Х	Exit clock suspend next cycle
	L	L	Χ	Х	Х	Χ	Х	Maintain clock suspend

Remark: H = High level, L = Low level, X = High or Low level (Don't care)

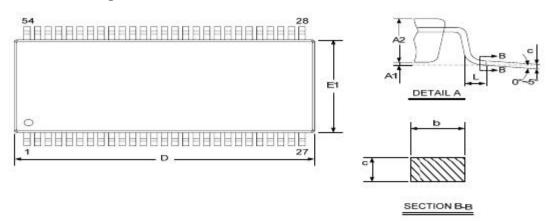
Notes 17: Self refresh can be entered only from the both banks idle state.

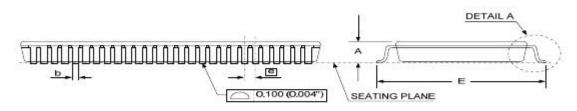
Power down can be entered only from both banks idle or row active state.

Notes 18: Must be legal command as defined in Operative Command Table

Package Description

TSOPII-54Pin Package





DIM	N	MILLIMETERS	3	INCHES			
Biivi	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	-	_	1.20		-	0.047	
A1	_	_	0.15	-	-	0.006	
A2	0.95	1.00	1.05	0.038	0.04	0.042	
b	0.30	_	0.45	0.012		0.018	
С	0.10	-	0.16	0.004	-	0.01	
D	22.13	_	22.38	0.871	-	0.881	
е		0.80 BASIC		(0.0315 BASIC)	
E	11.56	11.76	11.96	0.455	0.463	0.471	
E1	10.03	10.16	10.29	0.395	0.400	0.405	
L	0.58	0.60	0.62	0.016	0.024	0.032	